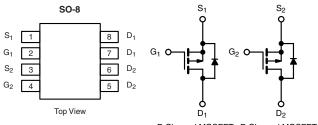
SQ4961EY



Vishay Siliconix

Automotive Dual P-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 60			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 \text{ V}$	0.085			
$R_{DS(on)}(\Omega)$ at V_{GS} = - 4.5 V	0.115			
I _D (A) per leg	- 4.4			
Configuration	Dual			



P-Channel MOSFET P-Channel MOSFET

FEATURES

- TrenchFET[®] Power MOSFET
- AEC-Q101 Qualified
- 100 % R_g and UIS Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ROHS COMPLIANT HALOGEN FREE

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and Halogen-free	SQ4961EY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	- 60	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C	L	- 4.4		
	T _C = 125 °C	I _D	- 2.5		
Continuous Source Current (Diode Conduction)		I _S	- 3	A	
Pulsed Drain Current ^a		I _{DM}	- 18		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 20		
Single Pulse Avalanche Energy		E _{AS}	20	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	D	3.3	w	
	T _C = 125 °C	P _D	1.1		
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^b	R _{thJA}	105	°C/W	
Junction-to-Foot (Drain)		R _{thJF}	45	0/10	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. When mounted on 1" square PCB (FR-4 material).

1 For technical questions, contact: <u>automostechsupport@vishay.com</u> www.vishay.com

Vishay Siliconix

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$		- 60	-	-	v
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$		- 2.0	- 2.5	
Gate-Source Leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = - 60 V	-	-	- 1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = -60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	- 50	μA
		$V_{GS} = 0 V$	$V_{DS} = -60 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	- 150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	$V_{DS} \le$ - 5 V	- 12	-	-	Α
		V _{GS} = - 10 V	I _D = - 3.5 A	-	0.070	0.085	Ω
Drain Course On State Registeres	Р	V _{GS} = - 10 V	I _D = - 3.5 A, T _J = 125 °C	-	-	0.142	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -10 V$	I _D = - 3.5 A, T _J = 175 °C	-	-	0.176	
		V _{GS} = - 4.5 V	I _D = - 2.5 A	-	0.095	0.115	
Forward Transconductanceb	9 _{fs}	V _{DS} =	V _{DS} = - 15 V, I _D = - 3.5 A		9	-	S
Dynamic ^b	-						
Input Capacitance	C _{iss}			-	912	1140	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V_{DS} = - 30 V, f = 1 MHz	-	100	125	
Reverse Transfer Capacitance	C _{rss}			-	60	75	
Total Gate Charge ^c	Qg			-	26.5	40	
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = -10 V$	V $V_{DS} = -30$ V, $I_D = -4.3$ A	-	3.8	-	nC
Gate-Drain Charge ^c	Q _{gd}			-	5.8	-	
Gate Resistance	R _g	f = 1 MHz		3	-	16	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	11	17	
Rise Time ^c	tr	$\label{eq:V_DD} \begin{array}{l} V_{\text{DD}} = -30 \ V, \ R_{\text{L}} = 8.8 \ \Omega \\ I_{\text{D}} \cong -3.4 \ A, \ V_{\text{GEN}} = -10 \ V, \ R_{g} = 1 \ \Omega \end{array}$		-	13	20	ns
Turn-Off Delay Time ^c	t _{d(off)}			-	36	54	
Fall Time ^c	t _f			-	8	12	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	- 18	А
Forward Voltage	V _{SD}	I _F = - 3 A, V _{GS} = 0 V		-	- 0.84	- 1.2	V

Notes

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

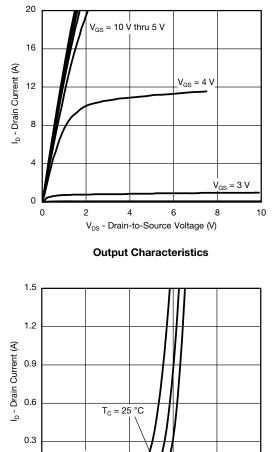
c. Independent of operating temperature.

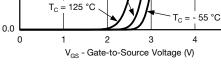
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



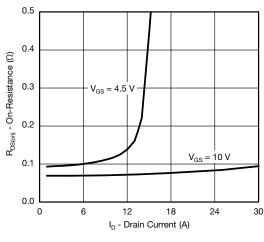
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



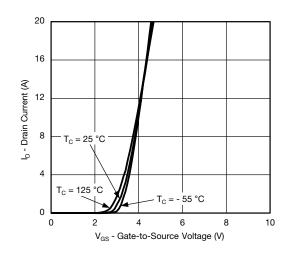


Transfer Characteristics

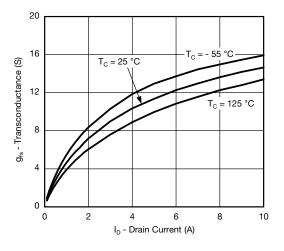
5



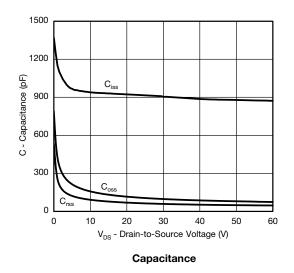
On-Resistance vs. Drain Current



Transfer Characteristics



Transconductance



S12-2907-Rev. B, 10-Dec-12

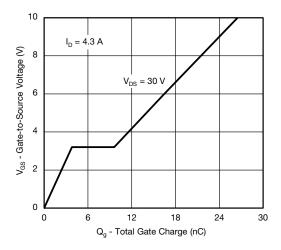
3

Document Number: 67539

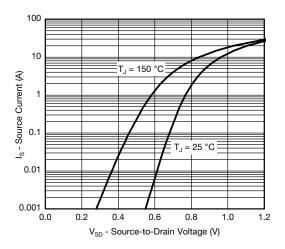
For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



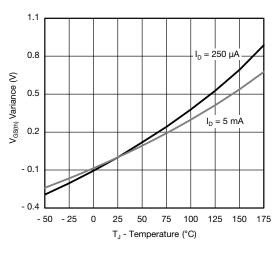
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



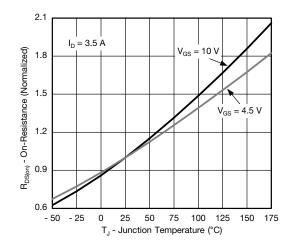
Gate Charge



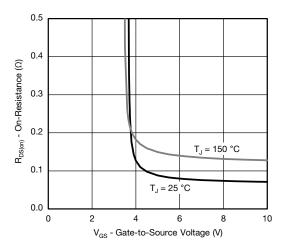
Source Drain Diode Forward Voltage

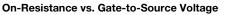


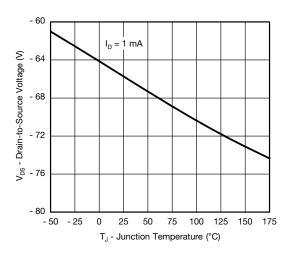
Threshold Voltage



On-Resistance vs. Junction Temperature







Drain Source Breakdown vs. Junction Temperature

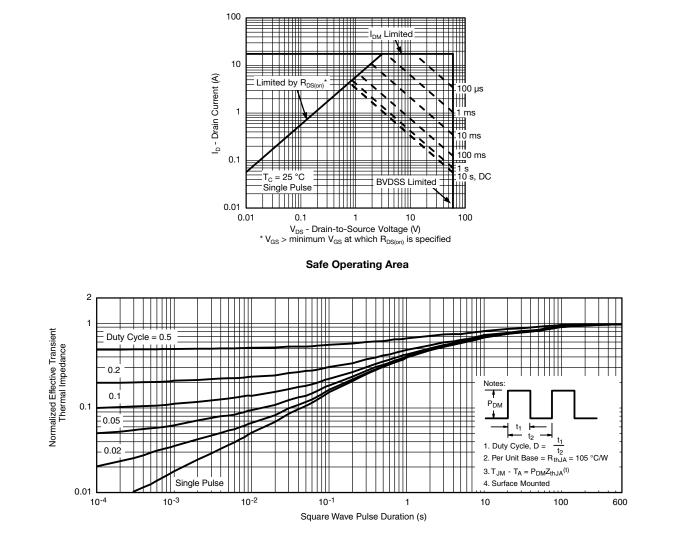
S12-2907-Rev. B, 10-Dec-12

Document Number: 67539

For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



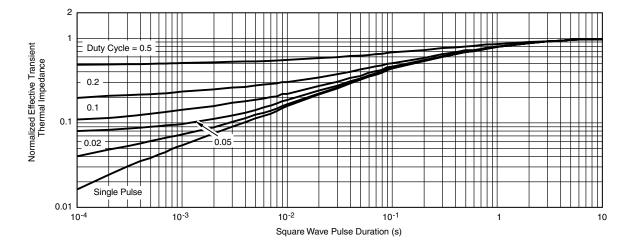
THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67539.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.